

OEG Miniature Relay PCF, MEAS G Series

TE Internal #: 6274020-1

TE Internal Description: JACK, VERTICAL, PCB, F SERIES

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Connectors > RF Connectors > Coax Connectors











RF Interface: **F Type**

RF Connector Style: Jack

RF Connector Mated Outer Diameter (Approximate): 7.62 mm [.3 in]

Impedance: 75Ω

RF Connector Coupling Mechanism: Push-On

Features

Product Type Features

RF Interface	F Type
RF Connector Style	Jack
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	1
Number of Coaxial Contacts	1

Electrical Characteristics

Impedance	75 Ω	

Body Features

Body Material	Zinc
Body Material Finish	Matte
Body Plating Material	Tin



Contact Features

RF Connector Center Contact Underplating Material	Nickel
RF Connector Center Contact Plating Material	Tin (Sn)
RF Connector Center Contact Material	Phosphor Bronze

Termination Features

Termination Method to PCB	Through Hole - Solder
Termination Post & Tail Length	2.92 mm[.115 in]

Mechanical Attachment

RF Connector Coupling Mechanism	Push-On
Connector Mounting Type	Board Mount
RF Contact Captivation Method	Mechanical
Detent	Without

Dimensions

Profile Height from PCB	33.53 mm[1.32 in]
RF Connector Mated Outer Diameter (Approximate)	7.62 mm[.3 in]

Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]

Operation/Application

Operating Frequency	1 GHz
-	

Packaging Features

Packaging Method Carton

Other

Dielectric Material	Polymethylpentene

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2020 (205)



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1)oes	not a	contain	REACH	SVHC

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC
	Free

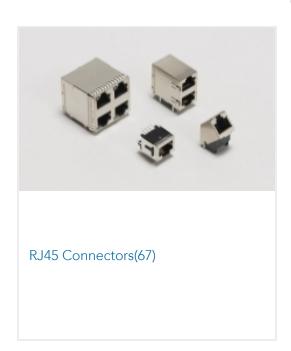
Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

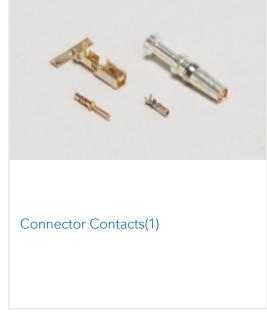
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

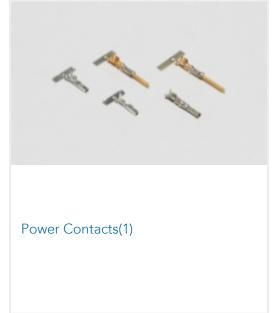
Also in the Series | MEAS G Series



Also in the Series | OEG Miniature Relay PCF













Customers Also Bought



Documents

Product Drawings

JACK, VERTICAL, PCB, F SERIES

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_6274020-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_6274020-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_6274020-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

F Series and G Series Connectors

English